INTEGRATED CIRCUITS



Product specification IC05 Data Handbook 1991 Feb 08



Philips Semiconductors

74ALS08

ТҮРЕ	TYPICAL PROPAGATION DELAY	TYPICAL SUPPLY CURRENT (TOTAL)
74ALS08	5.0ns	1.8mA

ORDERING INFORMATION

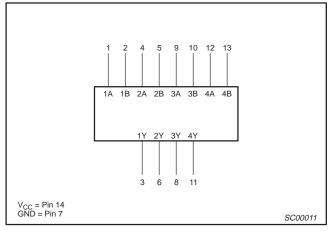
	ORDER CODE		
DESCRIPTION	COMMERCIAL RANGE V _{CC} = 5V ±10%, T _{amb} = 0°C to +70°C	DRAWING NUMBER	
14-pin plastic DIP	74ALS08N	SOT27-1	
14-pin plastic SO	74ALS08D	SOT108-1	
14-pin plastic SSOP Type II	74ALS08DB	SOT337-1	

INPUT AND OUTPUT LOADING AND FAN-OUT TABLE

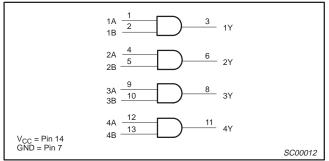
PINS	DESCRIPTION	74ALS (U.L.) HIGH/LOW	LOAD VALUE HIGH/LOW
nA, nB	Data inputs	1.0/1.0	20µA/0.1mA
nY	Data outputs	20/80	0.4mA/8mA

NOTE: One (1.0) ALS unit load is defined as: 20µA in the High state and 0.1mA in the Low state.

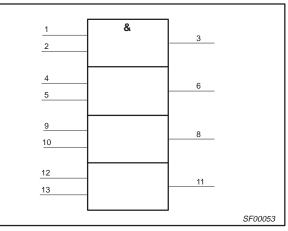
LOGIC SYMBOL



LOGIC DIAGRAM



IEC/IEEE SYMBOL



FUNCTION TABLE

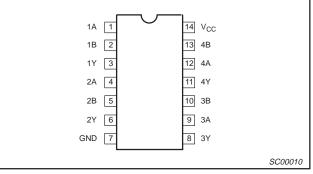
UTS	OUTPUT
nB	nΥ
Н	L
Х	н
L	Н
	nB H X L

H = High voltage level

L = Low voltage level

X = Don't care

PIN CONFIGURATION



74ALS08

ABSOLUTE MAXIMUM RATINGS

(Operation beyond the limit set forth in this table may impair the useful life of the device. Unless otherwise noted these limits are over the operating free-air temperature range.)

SYMBOL	PARAMETER	RATING	UNIT
V _{CC}	Supply voltage	-0.5 to +7.0	V
V _{IN}	Input voltage	-0.5 to +7.0	V
I _{IN}	Input current	-30 to +5	mA
V _{OUT}	Voltage applied to output in High output state	–0.5 to V_{CC}	V
I _{OUT}	Current applied to output in Low output state	16	mA
T _{amb}	Operating free-air temperature range	0 to +70	°C
T _{stg}	Storage temperature range	-65 to +150	°C

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER		UNIT		
STWBOL	PARAMETER	MIN	NOM	MAX	
V _{CC}	Supply voltage	4.5	5.0	5.5	V
V _{IH}	High-level input voltage	2.0			V
V _{IL}	Low-level input voltage			0.8	V
I _{lk}	Input clamp current			-18	mA
I _{OH}	High-level output current			-0.4	mA
I _{OL}	Low-level output current			8	mA
T _{amb}	Operating free-air temperature range	0		+70	°C

DC ELECTRICAL CHARACTERISTICS

(Over recommended operating free-air temperature range unless otherwise noted.)

CVMDO	SYMBOL PARAMETER							
STMBOL	PARAMETER		TEST CONDITIONS	5'	MIN	TYP ²	MAX	UNIT
V _{OH}	High-level output voltage		$V_{CC}\pm 10\%, V_{IL} = MAX, V_{IH} = MIN$, I _{OH} = -0.4mA	$V_{CC} - 2$			V
M			V _{CC} = MIN, V _{IL} = MAX,	I _{OL} = 4mA		0.25	0.40	V
VOL	V _{OL} Low-level output voltage		$V_{IH} = MIN$	I _{OL} = 8mA		0.35	0.50	V
V _{IK}	Input clamp voltage		$V_{CC} = MIN, \ I_I = I_{IK}$			-0.73	-1.5	V
lı	Input current at maximum input voltage		$V_{CC} = MAX, V_I = 7.0V$				0.1	mA
I _{IH}	High-level input current		$V_{CC} = MAX, V_I = 2.7V$				20	μΑ
IIL	Low-level input current		$V_{CC} = MAX, V_I = 0.5V$				-0.1	mA
Ι _Ο	Output current ³		$V_{CC} = MAX, V_{O} = 2.25V$		-30		-112	mA
1	CC Supply current (total)		V _{CC} = MAX	$V_{I} = 4.5V$		1.3	2.4	mA
			ACC = MWV	$V_I = 0V$		2.2	4.0	mA

NOTES:

1. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.

2. All typical values are at $V_{CC} = 5V$, $T_{amb} = 25^{\circ}C$. 3. The output conditions have been chosen to produce a current that closely approximate one half of the true short-circuit output current, I_{OS} .

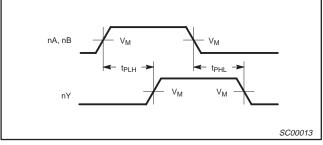
74ALS08

AC ELECTRICAL CHARACTERISTICS

			LIM		
SYMBOL PARAMETER		TEST CONDITION	T _{amb} = 0°C V _{CC} = +5. C _L = 50pF,	UNIT	
			MIN	МАХ	
t _{PLH} t _{PHL}	Propagation delay nA or nB to nY	Waveform 1	2.0 3.0	14.0 10.0	ns

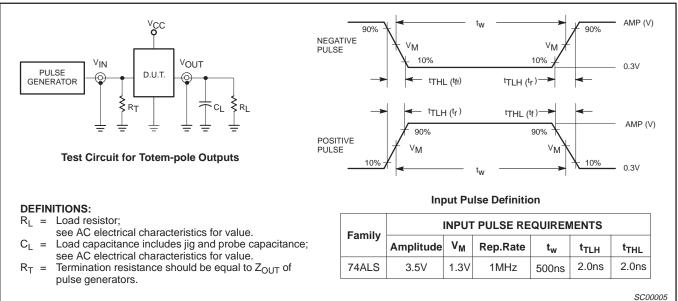
AC WAVEFORMS

For all waveforms, $V_M = 1.3V$.

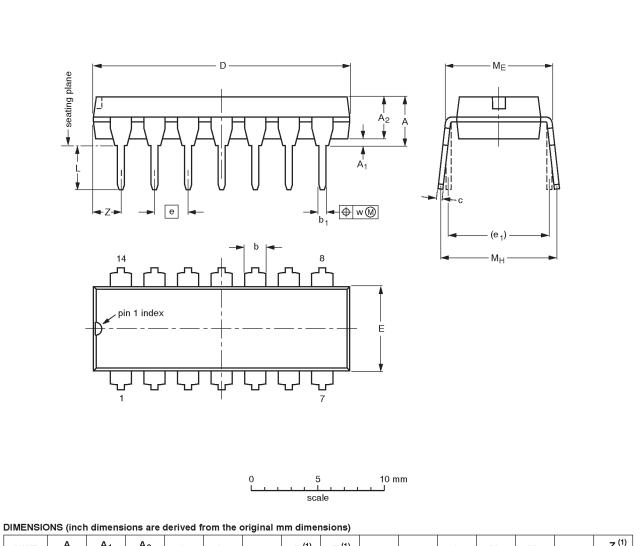


Waveform 1. Propagation Delay for Data to Output

TEST CIRCUIT AND WAVEFORMS



DIP14: plastic dual in-line package; 14 leads (300 mil)



UNIT	A max.	A ₁ min.	A ₂ max.	b	b ₁	c	D ⁽¹⁾	E ⁽¹⁾	e	e ₁	L	ME	M _H	w	Z ⁽¹⁾ max.
mm	4.2	0.51	3.2	1.73 1.13	0.53 0.38	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	2.2
inches	0.17	0.020	0.13	0.068 0.044	0.021 0.015	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.087

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

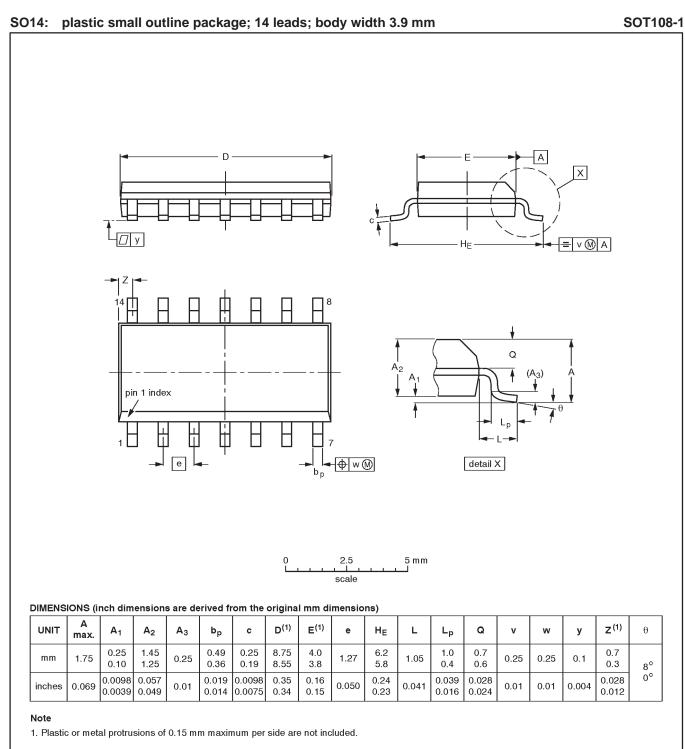
OUTLINE		EUROPEAN					
VERSION	IEC	JEDEC EI	EIAJ		PROJECTION	ISSUE DATE	
SOT27-1	050G04	MO-001AA				-92-11-17 95-03-11	

74ALS08

Product specification

Product specification

74ALS08



OUTLINE		EUROPEAN	ISSUE DATE				
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE	
SOT108-1	076E06S	MS-012AB				91-08-13- 95-01-23	

1991 Feb 08

74ALS08

	DEFINITIONS							
Data Sheet Identification	Product Status	Definition						
Objective Specification	Formative or in Design	This data sheet contains the design target or goal specifications for product development. Specifications may change in any manner without notice.						
Preliminary Specification	Preproduction Product	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.						
Product Specification	Full Production	This data sheet contains Final Specifications. Philips Semiconductors reserves the right to make changes at any time without notice, in order to improve design and supply the best possible product.						

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